

Silicon Carbide (SiC) Module – 8 mohm SiC M3S MOSFET, 1200 V, 2-PACK Half Bridge Topology, F1 Package

Product Preview

NXH008P120M3F1PTG, NXH008P120M3F1PG

The NXH008P120M3F1 is a power module containing 8 m Ω / 1200 V SiC MOSFET half–bridge and a thermistor in an F1 package.

Features

- $8 \text{ m}\Omega$ / 1200 V M3S SiC MOSFET Half-Bridge
- Thermistor
- Options with Pre-Applied Thermal Interface Material (TIM) and without Pre-Applied TIM
- Press-Fit Pins
- These Devices are Pb-Free, Halide Free and are RoHS Compliant

Typical Applications

- Solar Inverter
- Uninterruptible Power Supplies
- Electric Vehicle Charging Stations
- Industrial Power

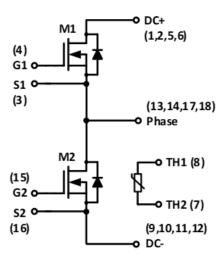
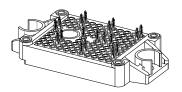


Figure 1. NXH008P120M3F1 Schematic Diagram

This document contains information on a product under development. **onsemi** reserves the right to change or discontinue this product without notice.

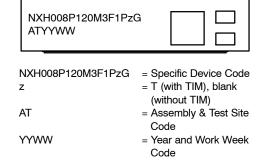
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PACKAGE PICTURE

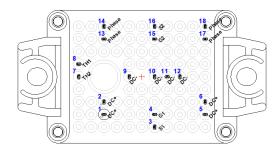


PIM18 33.8x42.5 (PRESS FIT) CASE 180BW

MARKING DIAGRAM



PIN CONNECTIONS



See Pin Function Description for pin names

ORDERING INFORMATION

See detailed ordering and shipping information on page 4 of this data sheet.

PIN FUNCTION DESCRIPTION

| Pin | Name | Description |
|-----|-------|-------------------------------------|
| 1 | DC+ | DC Positive Bus connection |
| 2 | DC+ | DC Positive Bus connection |
| 3 | S1 | M1 Kelvin Source (High side switch) |
| 4 | G1 | M1 Gate (High side switch) |
| 5 | DC+ | DC Positive Bus connection |
| 6 | DC+ | DC Positive Bus connection |
| 7 | TH2 | Thermistor Connection 2 |
| 8 | TH1 | Thermistor Connection 1 |
| 9 | DC- | DC Negative Bus connection |
| 10 | DC- | DC Negative Bus connection |
| 11 | DC- | DC Negative Bus connection |
| 12 | DC- | DC Negative Bus connection |
| 13 | PHASE | Center point of half bridge |
| 14 | PHASE | Center point of half bridge |
| 15 | G2 | M2 Gate (Low side switch) |
| 16 | S2 | M2 Kelvin Source (Low side switch) |
| 17 | PHASE | Center point of half bridge |
| 18 | PHASE | Center point of half bridge |

MAXIMUM RATINGS

| Rating | Symbol | Value | Unit |
|---|---------------------|------------|-----------|
| SIC MOSFET | | | • |
| Drain-Source Voltage | V _{DSS} | 1200 | V |
| Gate-Source Voltage | V _{GS} | +22/–10 | V |
| Continuous Drain Current @ T _c = 80°C (T _J = 175°C) | I _D | 145 | А |
| Pulsed Drain Current (T _J = 150°C) | I _{Dpulse} | 436 | А |
| Maximum Power Dissipation (T _J = 175°C) | P _{tot} | 382 | W |
| Minimum Operating Junction Temperature | T _{JMIN} | -40 | °C |
| Maximum Operating Junction Temperature | T _{JMAX} | 175 | °C |
| THERMAL PROPERTIES | | | |
| Storage Temperature Range | T _{stg} | -40 to 150 | °C |
| INSULATION PROPERTIES | | | |
| Isolation Test Voltage, t = 1 s, 60 Hz | V _{is} | 4800 | V_{RMS} |
| Creepage Distance | | 12.7 | mm |
| СТІ | | 600 | |
| Substrate Ceramic Material | | Al_2O_3 | |
| Substrate Ceramic Material Thickness | | 0.32 | mm |

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. Refer to ELECTRICAL CHARACTERISTICS, RECOMMENDED OPERATING RANGES and/or APPLICATION INFORMATION for Safe

RECOMMENDED OPERATING RANGES

| Rating | Symbol | Min | Max | Unit |
|---------------------------------------|--------|-----|-----|------|
| Module Operating Junction Temperature | T_J | -40 | 150 | °C |

Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability.

ELECTRICAL CHARACTERISTICS ($T_J = 25^{\circ}C$ unless otherwise noted)

| Parameter | Parameter Test Conditions | | Min | Тур | Max | Unit |
|---------------------------------|---|-----------------------|------|------|------|------|
| SIC MOSFET CHARACTERISTICS | | | | | | |
| Zero Gate Voltage Drain Current | V _{GS} = 0 V, V _{DS} = 1200 V, T _J = 25°C | I _{DSS} | = | - | 400 | μΑ |
| Drain-Source On Resistance | V _{GS} = 18 V, I _D = 120 A, T _J = 25°C | R _{DS(ON)} | = | 7.7 | 10.9 | mΩ |
| | V _{GS} = 18 V, I _D = 120 A, T _J = 125°C | | - | 12.6 | - | |
| | V _{GS} = 18 V, I _D = 120 A, T _J = 150°C | | - | 14.4 | _ | |
| | V _{GS} = 18 V, I _D = 120 A, T _J = 175°C | | - | 18.1 | - | |
| Gate-Source Threshold Voltage | $V_{GS} = V_{DS}$, $I_D = 60 \text{ mA}$ | V _{GS(TH)} | 2.04 | 2.4 | 4.4 | V |
| Internal Gate Resistance | | R _{GINT} | - | 0.8 | - | Ω |
| Gate Leakage Current | V _{GS} = -10 V / 22 V, V _{DS} = 0 V | I _{GSS} | -4 | - | 4 | μΑ |
| Input Capacitance | V _{DS} = 800 V, V _{GS} = 0 V, f = 1 MHz | C _{ISS} | - | 8334 | = | pF |
| Reverse Transfer Capacitance | 7 | C _{RSS} | - | 37 | = | |
| Output Capacitance | 7 | C _{OSS} | - | 472 | = | |
| Total Gate Charge | $V_{DS} = 800 \text{ V}, V_{GS} = -3/18 \text{ V}, I_D = 120 \text{ A}$ | Q _{G(TOTAL)} | _ | 419 | _ | nC |
| Gate-Source Charge | 7 | Q _{GS} | - | 61 | _ | nC |
| Gate-Drain Charge | 7 | Q _{GD} | - | 96 | _ | nC |

Operating parameters.

ELECTRICAL CHARACTERISTICS ($T_J = 25^{\circ}C$ unless otherwise noted) (continued)

| Parameter | Test Conditions | Symbol | Min | Тур | Max | Unit |
|---------------------------------------|--|---------------------|-----|-------|-----|------|
| SIC MOSFET CHARACTERISTICS | | • | | • | | |
| Turn-on Delay Time | T _J = 25°C | t _{d(on)} | _ | 17 | - | ns |
| Rise Time | V_{DS} = 800 V, I_D = 120 A V_{GS} = -3 V / 18 V, R_G = 2 Ω | t _r | _ | 17 | _ | |
| Turn-off Delay Time | | t _{d(off)} | _ | 97 | _ | |
| Fall Time | | t _f | _ | 12 | _ | |
| Turn-on Switching Loss per Pulse | | E _{ON} | _ | 1760 | _ | μJ |
| Turn-off Switching Loss per Pulse | | E _{OFF} | _ | 588 | _ | |
| Turn–on Delay Time | T _J = 150°C | t _{d(on)} | - | 15 | - | ns |
| Rise Time | V_{DS} = 800 V, I_D = 120 A V_{GS} = -3 V / 18 V, R_G = 2 Ω | t _r | = | 15 | = | |
| Turn-off Delay Time | | t _{d(off)} | = | 110 | = | |
| Fall Time | | t _f | - | 13 | - | |
| Turn-on Switching Loss per Pulse | | E _{ON} | - | 2155 | - | μJ |
| Turn-off Switching Loss per Pulse | | E _{OFF} | = | 745 | = | |
| Diode Forward Voltage | $V_{GS} = -3 \text{ V}, I_{SD} = 120 \text{ A}, T_J = 25^{\circ}\text{C}$ V_{SD} | | - | 4.67 | 6.2 | V |
| | V _{GS} = -3 V, I _{SD} = 120 A, T _J = 125°C |] | - | 4.45 | - | |
| | V _{GS} = -3 V, I _{SD} = 120 A, T _J = 150°C | | - | 4.4 | - | |
| Thermal Resistance - Chip-to-Case | M1, M2 | R_{thJC} | - | 0.249 | - | °C/W |
| Thermal Resistance - Chip-to-Heatsink | Thermal grease, Thickness = 2 Mil +2%, A = 2.8 W/mK | R _{thJH} | - | 0.466 | - | °C/W |
| THERMISTOR CHARACTERISTICS | | • | | • | | |
| Nominal Resistance | T = 25°C | R ₂₅ | = | 5 | = | kΩ |
| | T = 100°C | R ₁₀₀ | = | 493 | = | Ω |
| | T = 150°C | R ₁₅₀ | - | 159.5 | - | Ω |
| Deviation of R ₁₀₀ | T = 100°C | ΔR/R | -5 | _ | 5 | % |
| Power Dissipation – Recommended Limit | 0.15 mA, Non-self-heating Effect | P _D | - | 0.1 | - | mW |
| Power Dissipation – Absolute Maxiumum | 5 mA | P _D | - | 34.2 | - | mW |
| Power Dissipation Constant | | | - | 1.4 | - | mW/K |
| B-value | B (25/50), tolerance ±2% | | - | 3375 | - | K |
| B-value | B (25/100), tolerance ±2% | | _ | 3436 | _ | K |

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

ORDERING INFORMATION

| Orderable Part Number | Marking | Package | Shipping |
|-----------------------|-------------------|--|-------------------------|
| NXH008P120M3F1PTG | NXH008P120M3F1PTG | F1HALFBR: Case 180BW Press-fit Pins with pre-applied thermal interface material (TIM) (Pb-Free / Halide Free) | 28 Units / Blister Tray |
| NXH008P120M3F1PG | NXH008P120M3F1PG | F1HALFBR: Case 180BW Press-fit Pins (Pb-Free / Halide Free) | 28 Units / Blister Tray |

TYPICAL CHARACTERISTIC

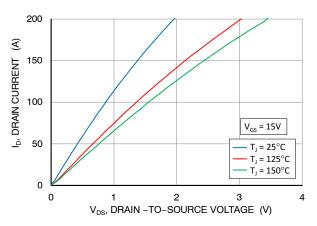


Figure 2. MOSFET Typical Output Characteristic V_{GS} = 15 V

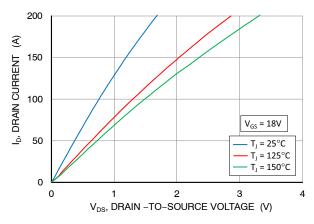


Figure 3. MOSFET Typical Output Characteristic V_{GS} = 18 V

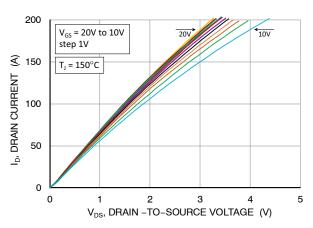


Figure 4. MOSFET Typical Output Characteristic V_{GS} = Var.

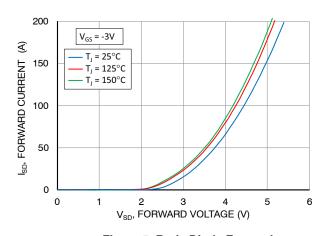


Figure 5. Body Diode Forward Characteristic

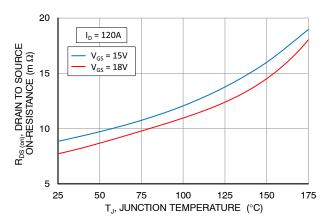


Figure 6. R_{DS(on)} Drain-to-Source ON Resistance vs. Junction Temperature

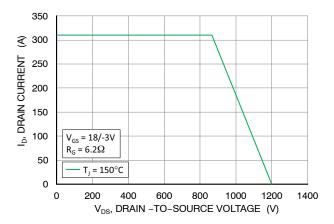


Figure 7. Reverse Bias Safe Operating Area (RBSOA)

TYPICAL CHARACTERISTICS

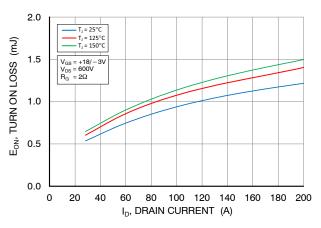


Figure 8. Switching on Loss vs. Drain Current $V_{DS} = 600 \text{ V}$

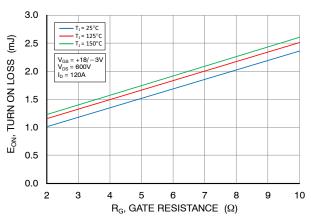


Figure 9. Switching on Loss vs. Gate Resistance V_{DS} = 600 V

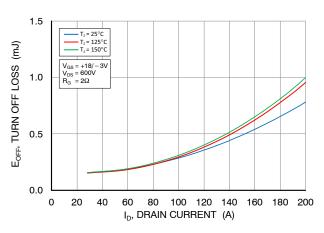


Figure 10. Switching off Loss vs. Drain Current $V_{DS} = 600 \text{ V}$

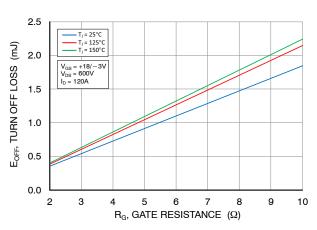


Figure 11. Switching off Loss vs. Gate Resistance $V_{DS} = 600 \text{ V}$

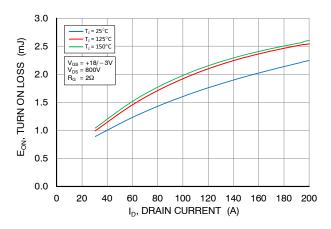


Figure 12. Switching on Loss vs. Drain Current $V_{DS} = 800 \text{ V}$

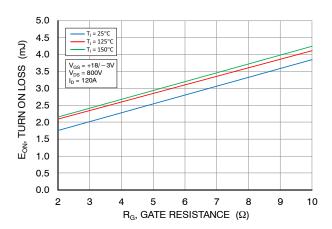


Figure 13. Switching on Loss vs. Gate Resistance V_{DS} = 800 V

TYPICAL CHARACTERISTICS

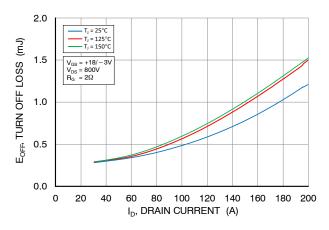


Figure 14. Switching off Loss vs. Drain Current V_{DS} = 800 V

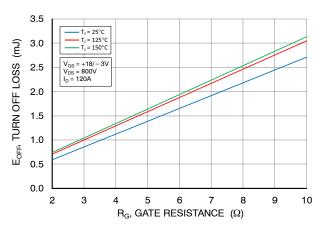


Figure 15. Switching off Loss vs. Gate Resistance V_{DS} = 800 V

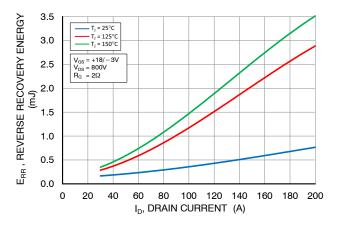


Figure 16. Reverse Recovery Energy vs.
Drain Current V_{DS} = 800 V

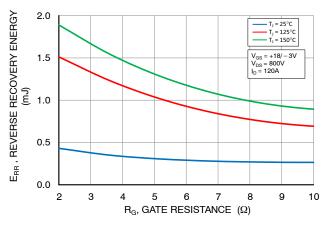


Figure 17. Reverse Recovery Energy vs. Gate Resistance V_{DS} = 800 V

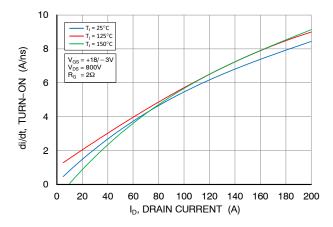


Figure 18. di/dt Turn ON vs. Drain Current V_{DS} = 800 V

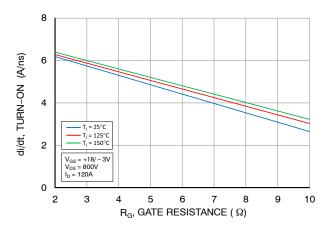


Figure 19. di/dt Turn ON vs. Gate Resistance V_{DS} = 800 V

TYPICAL CHARACTERISTICS

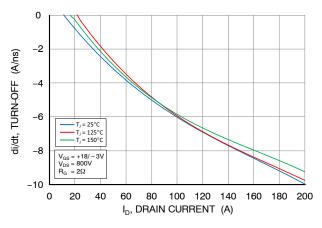


Figure 20. di/dt Turn OFF vs. Drain Current V_{DS} = 800 V

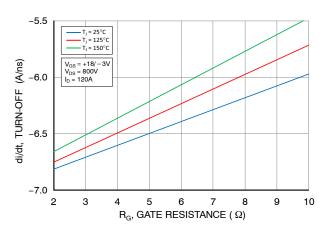


Figure 21. di/dt Turn OFF vs. Gate Resistance V_{DS} = 800 V

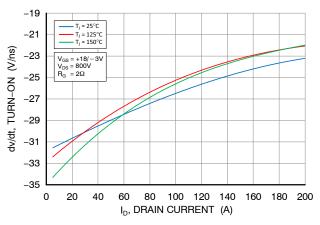


Figure 22. dv/dt Turn ON vs. Drain Current V_{DS} = 800 V

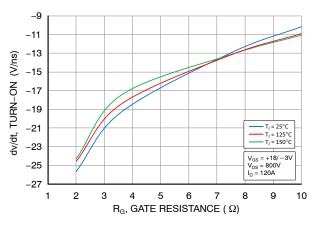


Figure 23. dv/dt Turn ON vs. Gate Resistance V_{DS} = 800 V

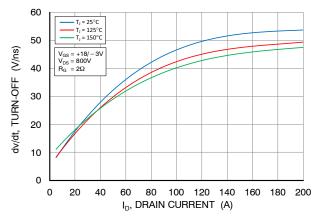


Figure 24. dv/dt Turn OFF vs. Drain Current V_{DS} = 800 V

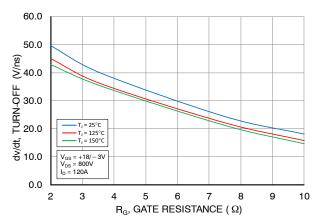


Figure 25. dv/dt Turn OFF vs. Gate Resistance V_{DS} = 800 V

TYPICAL CHARACTERISTICS

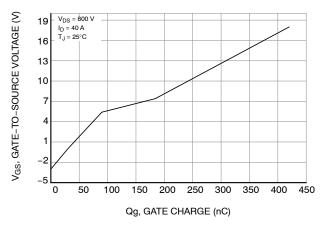


Figure 26. Gate-to-Source Voltage vs.
Total Charge

Figure 27. Capacitance vs. Drain-to-Source Voltage

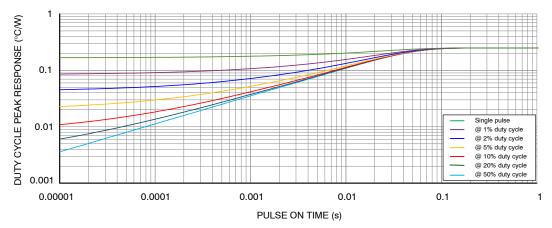


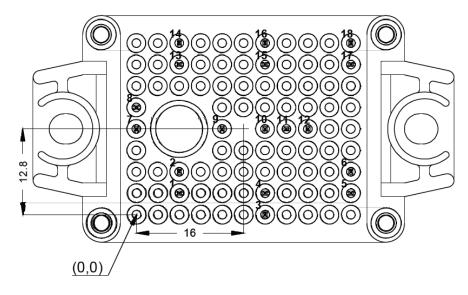
Figure 28. Duty Cycle Response vs. Pulse On Time

Table 1. CAUER NETWORKS

| Cauer Element # | Rth (K/W) | Cth (Ws/K) |
|-----------------|-----------|------------|
| 1 | 0.0015405 | 0.0032582 |
| 2 | 0.0034038 | 0.0011216 |
| 3 | 0.0167500 | 0.0053859 |
| 4 | 0.0498300 | 0.0154460 |
| 5 | 0.0925960 | 0.0870830 |
| 6 | 0.0540320 | 1.7250000 |

PIN POSITION INFORMATION

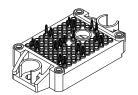
scale = 2.5 : 1



S Pin position

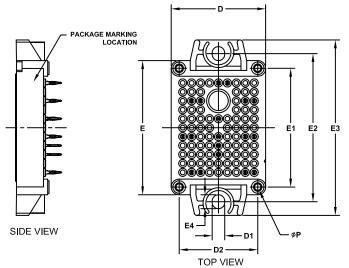
| Pin # | Х | Υ | Function | Pin # | Х | Υ | Function |
|-------|------|------|-----------|-------|------|------|----------|
| 1 | 6.4 | 3.2 | DC+ | 10 | 19.2 | 12.8 | DC- |
| 2 | 6.4 | 6.4 | DC+ | 11 | 22.4 | 12.8 | DC- |
| 3 | 19.2 | 0.0 | S1 | 12 | 25.6 | 12.8 | DC- |
| 4 | 19.2 | 3.2 | G1 | 13 | 6.4 | 22.4 | Phase |
| 5 | 32.0 | 3.2 | DC+ | 14 | 6.4 | 25.6 | Phase |
| 6 | 32.0 | 6.4 | DC+ | 15 | 19.2 | 22.4 | G2 |
| 7 | 0.0 | 12.8 | TH2 | 16 | 19.2 | 25.6 | S2 |
| 8 | 0.0 | 16.0 | TH1 | 17 | 32.0 | 22.4 | Phase |
| 9 | 12.8 | 12.8 | DC- | 18 | 32.0 | 25.6 | Phase |





PIM18 33.8x42.5 (PRESS FIT) CASE 180BW ISSUE B

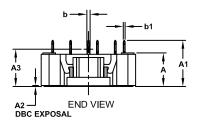
DATE 30 APR 2021

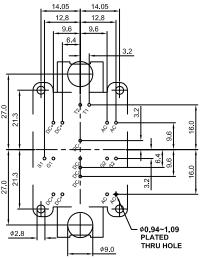


NOTES:

- 1. CONTROLLING DIMENSION: MILLIMETERS
- 2. PIN POSITION TOLERANCE IS ± 0.4mm

| | MILLIMETERS | | | |
|-----|-------------|-------|-------|--|
| DIM | MIN. | NOM. | MAX. | |
| Α | 11.65 | 12.00 | 12,35 | |
| A1 | 16.00 | 16.50 | 17.00 | |
| A2 | 0.00 | 0.35 | 0.60 | |
| A3 | 12.85 | 13.35 | 13.85 | |
| b | 1.15 | 1.20 | 1.25 | |
| b1 | 0.59 | 0.64 | 0.69 | |
| D | 33.50 | 33.80 | 34.10 | |
| D1 | 4.40 | 4.50 | 4.60 | |
| D2 | 27.95 | 28.10 | 28.25 | |
| Е | 47.70 | 48.00 | 48.30 | |
| E1 | 42.35 | 42.50 | 42.65 | |
| E2 | 52.90 | 53.00 | 53.10 | |
| E3 | 62.30 | 62.80 | 63.30 | |
| E4 | 4.90 | 5.00 | 5.10 | |
| Р | 2.20 | 2.30 | 2.40 | |





GENERIC MARKING DIAGRAM*

RECOMMENDED MOUNTING PATTERN

XXXXX = Specific Device Code
AT = Assembly & Test Site Code

YYWW = Year and Work Week Code

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "•", may or may not be present. Some products may not follow the Generic Marking.

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